

Realtek Semiconductor Corp.

No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Attestation Statements

Date: 2025/2/4

Federal Communications Commission
Authorization and Evaluation Division
7435 Oakland Mills Road
Columbia MD 21046
USA

Subject: Attestation Statements Part 2.911(d)(5)(i)-(ii) Filing

FCC ID : TX2-RTL8852CE

To Whom It May Concern:

Statement for 47 CFR section 2.911(d)(5)(i)

Realtek Semiconductor Corp. ("the applicant") certifies that the equipment for which authorization is sought **is not** "covered" equipment prohibited from receiving an equipment authorization pursuant to section 2.903 of the FCC rules.

Statement for 47 CFR section 2.911(d)(5)(ii)

Realtek Semiconductor Corp. ("the applicant") certifies that, as of the date of the filing of the application, the applicant **is not** identified on the Covered List (as a specifically named entity or any of its subsidiaries or affiliates) as an entity producing "covered" equipment.

Respectfully,

Applicant's company name : Realtek Semiconductor Corp.

Applicant's company address : No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Signature : 

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